

HAT2140H

Silicon N Channel Power MOS FET Power Switching

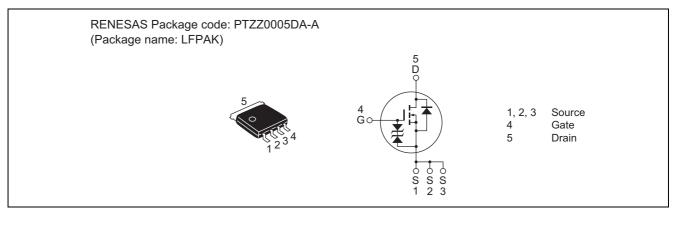
REJ03G1192-0400 (Previous: ADE-208-1581B) Rev.4.00 Sep 07, 2005

Features

- Capable of 7 V gate drive
- Low drive current
- High density mounting
- Low on-resistance

 $R_{DS\ (on)}$ = 12.5 m Ω typ. (at V_{GS} = 10 V)

Outline





Absolute Maximum Ratings

			$(Ta = 25^{\circ}C)$
Item	Symbol	Value	Unit
Drain to source voltage	V _{DSS}	100	V
Gate to source voltage	V _{GSS}	±20	V
Drain current	ID	25	А
Drain peak current	I _{D (pulse)} Note 1	100	A
Body-drain diode reverse drain current	I _{DR}	25	А
Avalanche current	I _{AP} Note 3	25	А
Avalanche energy	E _{AR} Note 3	62.5	mJ
Channel dissipation	Pch Note 2	30	W
Channel temperature	Tch	150	°C
Storage temperature	Tstg	-55 to +150	°C

Notes: 1. PW \leq 10 μ s, duty cycle \leq 1%

2. Tc = 25 °C

3. Value at Tch = 25°C, Rg \ge 50 Ω

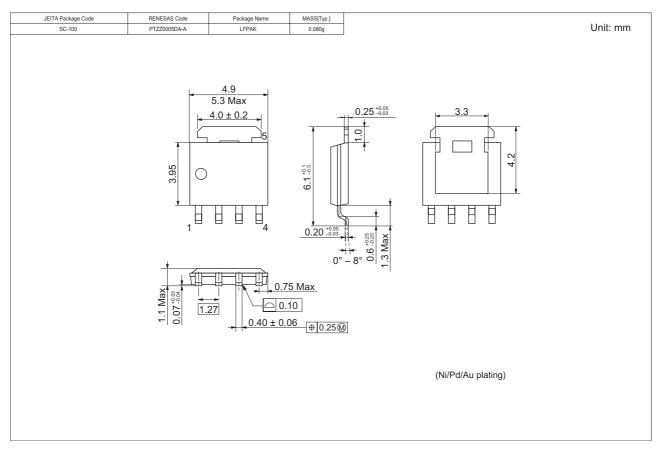
Electrical Characteristics

						(Ta = 25°C)
Item	Symbol	Min	Тур	Max	Unit	Test Conditions
Drain to source breakdown voltage	V (BR) DSS	100	—	_	V	$I_D = 10 \text{ mA}, V_{GS} = 0$
Gate to source breakdown voltage	V (BR) GSS	±20	—	_	V	$I_G = \pm 100 \ \mu A, \ V_{DS} = 0$
Gate to source leak current	I _{GSS}	—	—	±10	μA	$V_{GS} = \pm 16 \text{ V}, V_{DS} = 0$
Zero gate voltage drain current	I _{DSS}	—	—	1	μA	$V_{DS} = 100 V, V_{GS} = 0$
Gate to source cutoff voltage	V _{GS (off)}	2.0	—	3.5	V	$V_{DS} = 10 \text{ V}, \text{ I}_{D} = 1 \text{ mA}$
Static drain to source on state resistance	R _{DS (on)}	—	12.5	16.0	mΩ	$I_D = 12.5 \text{ A}, V_{GS} = 10 \text{ V}^{Note 4}$
	R _{DS (on)}	—	13.5	18.0	mΩ	$I_D = 12.5 \text{ A}, V_{GS} = 7 \text{ V}^{Note 4}$
Forward transfer admittance	y _{fs}	27	45	—	S	$I_D = 12.5 \text{ A}, V_{DS} = 10 \text{ V}^{Note 4}$
Input capacitance	Ciss	—	6500	—	pF	V _{DS} = 10 V
Output capacitance	Coss	—	480	_	pF	$V_{GS} = 0$
Reverse transfer capacitance	Crss	—	210	_	pF	f = 1 MHz
Total gate charge	Qg		105	_	nC	V _{DD} = 50 V
Gate to source charge	Qgs		20	—	nC	V _{GS} = 10 V
Gate to drain charge	Qgd		22	_	nC	I _D = 25 A
Turn-on delay time	t _{d (on)}	—	25	_	ns	V_{GS} = 10 V, I_{D} = 12.5 A
Rise time	tr	—	24	_	ns	$V_{DD} \cong 30 \text{ V}$
Turn-off delay time	t _{d (off)}	—	100	_	ns	$R_L = 2.4 \Omega$
Fall time	t _f		12		ns	Rg = 4.7 Ω
Body-drain diode forward voltage	V _{DF}		0.83	1.08	V	$I_F = 25 \text{ A}, V_{GS} = 0^{\text{Note 4}}$
Body-drain diode reverse recovery time	t _{rr}		55		ns	$I_F = 25 \text{ A}, V_{GS} = 0$
						di _F /dt = 100 A/µs

Note: 4. Pulse test



Package Dimensions



Ordering Information

Part Name	Quantity	Shipping Container
HAT2140H-EL-E	2500 pcs	Taping

Note: For some grades, production may be terminated. Please contact the Renesas sales office to check the state of production before ordering the product.



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